

HMC306AMS10 / 306AMS10E

v00.1113



0.5 DB LSB GAAS MMIC 5-BIT DIGITAL ATTENUATOR, 0.7 - 3.8 GHz

Typical Applications

The HMC306AMS10 / 306AMS10E is ideal for:

- Cellular; UMTS/3G Infrastructure
- ISM, MMDS, WLAN, WIMAX
- Microwave Radio & VSAT
- Test Equipment and Sensors

Features

RoHS-Compliant Product

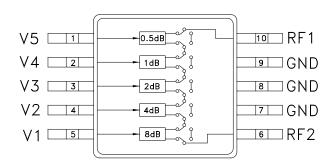
0.5 dB LSB Steps to 15.5 dB

Single Positive Control Per Bit

± 0.2 dB Typical Bit Error

Miniature 15 mm² Package: MSOP10

Functional Diagram



General Description

The HMC306AMS10 & HMC306AMS10E are general purpose broadband 5-bit positive control GaAs IC digital attenuators in 10 lead MSOP surface mount plastic packages. Covering 0.7 to 3.8 GHz, the insertion loss is typically less than 1.5 to 2.3 dB. These attenuators' bit values are 0.5 (LSB), 1, 2, 4 and 8 dB for a total attenuation of 15.5 dB. Attenuation accuracy is excellent at ± 0.2 dB typical with an IIP3 of up to +52 dBm. Five bit control voltage inputs, toggled between 0 and +3 to +5V, are used to select each attenuation state. A single Vdd bias of +3 to +5V applied through an external 5K Ohm resistor is required.

Electrical Specifications,

 $T_A = +25^{\circ}$ C, Vdd= +3V to +5V & VCTL= 0/Vdd (Unless Otherwise Stated)

Parameter		Frequency (GHz)	Min.	Typical	Max.	Units
Insertion Loss		0.7 - 1.4 1.4 - 2.3 2.3 - 2.7 2.7 - 3.8		1.3 1.5 1.8 2.3	1.6 2.0 2.5 2.7	dB dB dB dB
Attenuation Range				15.5		dB
Return Loss (RF1 & RF2, All Atten. States)		0.7 - 1.4 1.4 - 2.3 2.3 - 2.7 2.7 - 3.8	15 14 13 10	21 18 16 13		dB dB dB dB
Attenuation Accuracy: (Referenced to Insertion Loss) All Attenuation States 0.5 - 7.5 dB States 8.0 - 15.5 dB States All Attenuation States		0.7 - 1.4 1.4 - 2.3 1.4 - 2.3 2.3 - 3.8	± (0.25 + 5 ± (0.15 + 5	0 + 5% of Atten. Setting) Max. 5 + 3% of Atten. Setting) Max. 5 + 3% of Atten. Setting) Max. 0 + 3% of Atten. Setting) Max.		dB dB dB dB
Input Power for 0.1 dB Compression	Vdd = 5V Vdd = 3V	0.7 - 3.8		28 27		dBm dBm
Input Third Order Intercept Point (Two-tone Input Power = 10 dBm Each Tone)	Vdd = 5V Vdd = 3V	0.7 - 3.8		52 48		dBm dBm
Switching Characteristics						
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)		0.7 - 3.8		560 600		ns ns



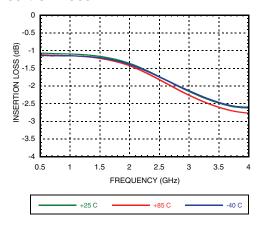
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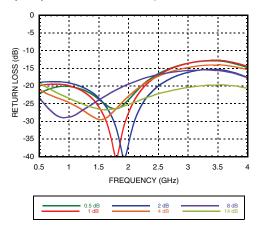
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Insertion Loss



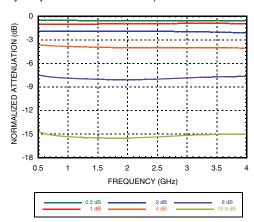
Return Loss RF1, RF2

(Only Major States are Shown)

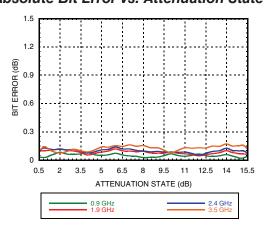


Normalized Attenuation

(Only Major States are Shown)

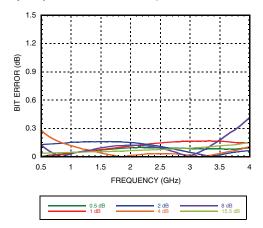


Absolute Bit Error vs. Attenuation State



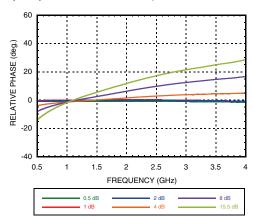
Absolute Bit Error vs. Frequency

(Only Major States are Shown)



Relative Phase vs. Frequency

(Only Major States are Shown)





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Truth Table

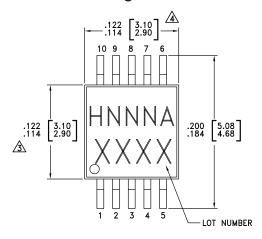
	Cont	Attenuation			
V1 8 dB	V2 4 dB	V3 2 dB	V4 1 dB	V5 0.5 dB	State RF1 - RF2
High	High	High	High	High	Reference I.L.
High	High	High	High	Low	0.5 dB
High	High	High	Low	High	1 dB
High	High	Low	High	High	2 dB
High	Low	High	High	High	4 dB
Low	High	High	High	High	8 dB
Low	Low	Low	Low	Low	15.5 dB Max. Atten.

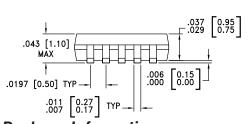
Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing





Control & Bias Voltages

State	Bias Condition		
Low	0 to +0.2V @ 20 μA Max.		
High	Vdd ± 0.2V @ 20 μA Max.		
Note: Vdd = +3V to	5V ± 0.2V		

Absolute Maximum Ratings

Control Voltage (V1 - V5)	Vdd + 0.2 Vdc	
Bias Voltage (Vdd)	+8 Vdc	
Channel Temperature	150 °C	
Continuous Pdiss (T = 85 °C)	0.506 W	
(derate 7.8 mW/ °C above 85 °C)	0.500 VV	
Thermal Resistance	128.5 °C/w	
(Channel to package bottom)	120.5 C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
RF Input Power (0.7 - 3.8 GHz)	+27 dBm	
ESD Sensitivity (HBM)	Class 1A	

NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
 - 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Part Number Package Body Material		MSL Rating	Package Marking [3]	
HMC306AMS10	2306AMS10 Low Stress Injection Molded Plastic		MSL1 [1]	H306A XXXX	
HMC306AMS10E RoHS-compliant Low Stress Injection Molded Plastic		100% matte Sn	MSL1 [2]	H306A XXXX	

 $\begin{bmatrix} 0.22 \\ -0.03 \end{bmatrix}$

- [1] Max peak reflow temperature of 235 $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX